

STP410N4F7AG

Automotive-grade N-channel 40 V, 1.5 mΩ typ., 180 A STripFET™ F7 Power MOSFET in a TO-220 package

Datasheet - production data



Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	RDS(on) max. ID PT(Ртот
STP410N4F7AG	40 V	1.8 mΩ	180 A	365 W

- Designed for automotive applications and AEC-Q101 qualified
- Among the lowest R_{DS(on)} on the market
- Excellent FoM (figure of merit)
- Low C_{rss}/C_{iss} ratio for EMI immunity
- High avalanche ruggedness

Applications

Switching applications

Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1: Device summarv

Order code	Marking	Package	Packing	
STP410N4F7AG	410N4F7	TO-220	Tube	

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
Vds	Drain-source voltage	40	V	
V _{GS}	Gate-source voltage	±20	V	
lp ⁽¹⁾	Drain current (continuous) at T _{case} = 25 °C	180	٨	
ID. 7	Drain current (continuous) at T _{case} = 100 °C	180	A	
I _{DM} ⁽²⁾	Drain current (pulsed)	720	А	
Ртот	Total dissipation at T _{case} = 25 °C	365	W	
Eas ⁽³⁾	Single pulse avalanche energy	1.9	J	
T _{stg}	Storage temperature range	55 to 175	•0	
Tj	Operating junction temperature range	-55 to 175 °C		

Notes:

 $^{(1)}$ Current is limited by package, the current capability of the silicon is 350 A at 25 °C.

⁽²⁾ Pulse width is limited by safe operating area.

 $^{(3)}T_j \le 175 \ ^{\circ}C, \ I_{av}=80A$

Table 3: Thermal data

Symbol	Parameter	Value	Unit	
Rthj-case	Thermal resistance junction-case	0.41	°C 111	
R _{thj-amb}	Thermal resistance junction-ambient max	62.5	°C/W	



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	40			V
	Zoro goto voltago droin	V_{GS} = 0 V, V_{DS} = 40 V			10	
IDSS	Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 40 V,$ $T_{case} = 125 °C^{(1)}$			100	μA
Igss	Gate-body leakage current	$V_{DS} = 0 V, V_{GS} = 20 V$			200	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2.5		4.5	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 90 \text{ A}$		1.5	1.8	mΩ

Notes:

⁽¹⁾Defined by design, not subject to production test.

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	11700	-	
Coss	Output capacitance	V _{DS} = 25 V, f = 1 MHz, V _{GS} = 0 V	-	3500	-	pF
C _{rss}	Reverse transfer capacitance	VDS - 20 V, I - I WIIZ, VGS - 0 V		390	-	P
Qg	Total gate charge	V _{DD} = 20 V, I _D = 180 A, V _{GS} = 10 V	-	140	-	
Q _{gs}	Gate-source charge	(see Figure 14: "Test circuit for	-	65	-	nC
Q _{gd}	Gate-drain charge	gate charge behavior")	-	27	-	

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 20 \text{ V}, \text{ I}_{D} = 90 \text{ A R}_{G} = 4.7 \Omega,$	-	35	-	
tr	Rise time	$V_{GS} = 20$ V, $I_{GS} = 90$ A $R_{G} = 4.7 \Omega$, $V_{GS} = 10$ V (see Figure 13: "Test circuit for resistive load switching times" and)	-	200	-	
t _{d(off)}	Turn-off delay time		-	110	-	ns
t _f	Fall time		-	44	-	

Electrical characteristics

	Table 7: Source-drain diode						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
Isd ⁽¹⁾	Source-drain current		-		180	А	
Vsd ⁽²⁾	Forward on voltage	$V_{GS} = 0 V, I_{SD} = 90 A$	-		1.3	V	
trr	Reverse recovery time	I _{SD} = 180 A, di/dt = 100 A/µs,	-	74.4		ns	
Qrr	Reverse recovery charge	$V_{DD} = 32 \text{ V}, \text{ T}_{\text{j}} = 25 \text{ °C}$ (see Figure 15: "Test circuit for inductive load	-	115		nC	
Irrm	Reverse recovery current	switching and diode recovery times")	-	3.1		А	

Notes:

 $^{(1)}$ Current is limited by package, the current capability of the silicon is 350 A at 25 °C.

 $^{(2)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.



100

50

0



 $V_{GS} = 5V$

5

 $\overline{V}_{DS}(V)$

4

3

2



300

200

100

0∟ 3.5 T_J = 175 °C

4 4.5 5 5.5 6

T₁ = 55 °C

6.5

V_{GS} (V)

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Electrical characteristics







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3 Test circuits







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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.











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Package information

F/AG			Package Information
	Table 8: TO-220 ty	be A mechanical data	
Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10.00		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øP	3.75		3.85
Q	2.65		2.95



5 Revision history

Table 9: Document revision history

Date	Revision	Changes
25-May-2016	1	First release.



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